Electronic Pate	nt App	lication Fee	Transm	ittal			
Application Number:	105	10581111					
Filing Date:	31-	31-May-2006					
Title of Invention:		METHOD FOR THE MOLECULAR BONDING OF MICROELECTRONIC COMPONENTS TO A POLYMER FILM					
First Named Inventor/Applicant Name:	Hu	Hubert Moriceau					
Filer:	Ma	Marvin Jay Spivak/Sinee Samla Samla					
Attorney Docket Number:	291	291619US0PCT					
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371 Fil	ling Fee	5					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1510	1510		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	2	3	6
	Tot	1816		